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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	32
Program Memory Size	32KB (32K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-BSSOP (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323heh4832g

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Development Features

Table 2 lists the features of ZiLOG[®]'s ZGP323H members.

Table 2. Features

Device	OTP (KB)	RAM (Bytes)	I/O Lines	Voltage Range
ZGP323H OTP MCU Family	4, 8, 16, 32	237	32, 24 or 16	2.0V–5.5V

- Low power consumption–18mW (typical)
- T = Temperature
 - S = Standard 0° to +70°C
 - $E = Extended -40^{\circ} to +105^{\circ}C$
 - A = Automotive -40° to $+125^{\circ}$ C
- Three standby modes:
 - STOP— (typical 1.8µA)
 - HALT— (typical 0.8mA)
 - Low voltage reset
- Special architecture to automate both generation and reception of complex pulses or signals:
 - One programmable 8-bit counter/timer with two capture registers and two load registers
 - One programmable 16-bit counter/timer with one 16-bit capture register pair and one 16-bit load register pair
 - Programmable input glitch filter for pulse reception
- Six priority interrupts
 - Three external
 - Two assigned to counter/timers
 - One low-voltage detection interrupt
- Low voltage detection and high voltage detection flags
- Programmable Watch-Dog Timer/Power-On Reset (WDT/POR) circuits
- Two independent comparators with programmable interrupt polarity
- Programmable EPROM options
 - Port 0: 0–3 pull-up transistors
 - Port 0: 4–7 pull-up transistors





Figure 2. Counter/Timers Diagram

Pin Description

The pin configuration for the 20-pin PDIP/SOIC/SSOP is illustrated in Figure 3 and described in Table 4. The pin configuration for the 28-pin PDIP/SOIC/SSOP are depicted in Figure 4 and described in Table 5. The pin configurations for the 40-pin PDIP and 48-pin SSOP versions are illustrated in Figure 5, Figure 6, and described in Table 6.

For customer engineering code development, a UV eraseable windowed cerdip packaging is offered in 20-pin, 28-pin, and 40-pin configurations. ZiLOG does not recommend nor guarantee these packages for use in production.



Capacitance

Table 8 lists the capacitances.

Table 8. Capacitance

Parameter	Maximum			
Input capacitance	12pF			
Output capacitance	12pF			
I/O capacitance	12pF			
Note: $T_A = 25^{\circ}$ C, $V_{CC} = GND = 0$ V, f = 1.0 MHz, unmeasured pins returned to GND				

DC Characteristics

Table 9. GP323HS DC Characteristics

T _A =0°C to +70°C								
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions N	lotes
V _{CC}	Supply Voltage		2.0		5.5	V	See Note 5 5	i
V _{CH}	Clock Input High Voltage	2.0-5.5	0.8 V _{CC}		V _{CC} +0.3	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.4	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0-5.5	0.7 V _{CC}		V _{CC} +0.3	V		
V _{IL}	Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.2 V _{CC}	V		
V _{OH1}	Output High Voltage	2.0-5.5	V _{CC} -0.4			V	$I_{OH} = -0.5 \text{mA}$	
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	I _{OL} = 4.0mA	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{CC} 1.75	V		
Ι _{ΙL}	Input Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	225		675	KΩ	V _{IN} = 0V; Pullups selected by mask	
		3.6V	75		275	KΩ	option	
		5.0V	40		160	KΩ		



			T _A = -40°0	C to +105	°C			
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0 \text{mA}$	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
IIL	Input Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200.0		700.0	KΩ	V _{IN} = 0V; Pullups selected by mask	
		3.6V	50.0		300.0	KΩ	option	
		5.0V	25.0		175.0	KΩ	-	
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0V, V_{CC}$	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
		5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current	2.0V		0.5	1.6	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
	(HALT Mode)	3.6V		0.8	2.0	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		5.5V		1.3	3.2	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
I _{CC2}	Standby Current (Stop	2.0V		1.6	12	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
	Mode)	3.6V		1.8	15	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		5.5V		1.9	18	μA	$V_{IN} = 0 V, V_{CC} WDT not Running$	3
		2.0V		5	30	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6V		8	40	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		5.5V		15	60	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V_{LVD}	V _{CC} Low Voltage Detection			2.4		V		
V _{HVD}	Vcc High Voltage Detection			2.7		V		
-								

Table 10. GP323HE DC Characteristics (Continued)

Notes:

1. All outputs unloaded, inputs at rail.

2. CL1 = CL2 = 100 pF.

3. Oscillator stopped.

4. Oscillator stops when V_{CC} falls below V_{BO} limit.

 It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to VCC and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.

6. Comparator and Timers are on. Interrupt disabled.

7. Typical values shown are at 25 degrees C.



AC Characteristics



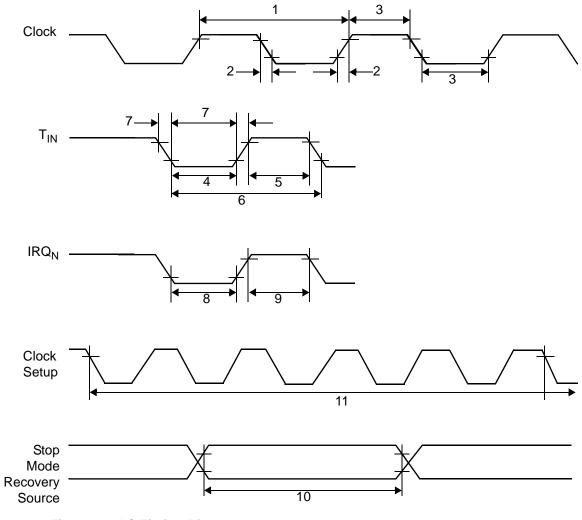


Figure 8. AC Timing Diagram



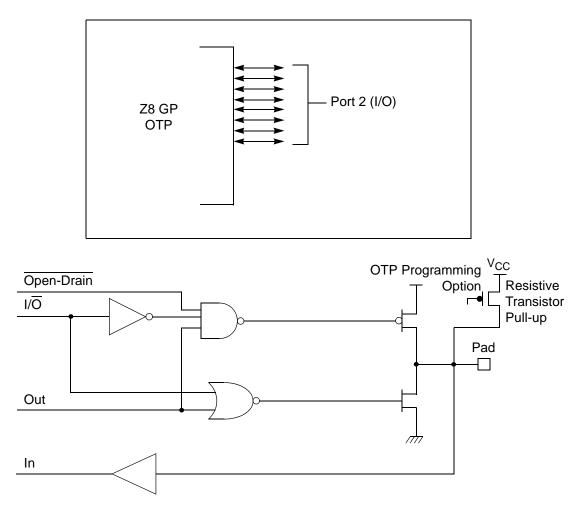


Figure 11. Port 2 Configuration

Port 3 (P37–P30)

Port 3 is a 8-bit, CMOS-compatible fixed I/O port (see Figure 12). Port 3 consists of four fixed input (P33–P30) and four fixed output (P37–P34), which can be configured under software control for interrupt and as output from the counter/timers. P30, P31, P32, and P33 are standard CMOS inputs; P34, P35, P36, and P37 are push-pull outputs.



Field	Bit Position		Value	Description
T16_Enable	7	R	0*	Counter Disabled
			1	Counter Enabled
		W	0	Stop Counter
			1	Enable Counter
Single/Modulo-N	-6	R/W		Transmit Mode
			0*	Modulo-N
			1	Single Pass
				Demodulation Mode
			0	T16 Recognizes Edge
			1	T16 Does Not Recognize
				Edge
Time_Out	5	R	0*	No Counter Timeout
			1	Counter Timeout
				Occurred
		W	0	No Effect
			1	Reset Flag to 0
T16 _Clock	43	R/W	00**	SCLK
			01	SCLK/2
			10	SCLK/4
			11	SCLK/8
Capture_INT_Mask	2	R/W	0**	Disable Data Capture Int.
			1	Enable Data Capture Int.
Counter_INT_Mask	1-	R/W	0*	Disable Timeout Int.
				Enable Timeout Int.
P35_Out	0	R/W	0*	P35 as Port Output
			1	T16 Output on P35

Table 17. CTR2(D)02H: Counter/Timer16 Control Register

Note:

*Indicates the value upon Power-On Reset.

**Indicates the value upon Power-On Reset. Not reset with a Stop Mode recovery.

T16_Enable

This field enables T16 when set to 1.

Single/Modulo-N

In TRANSMIT Mode, when set to 0, the counter reloads the initial value when it reaches the terminal count. When set to 1, the counter stops when the terminal count is reached.



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When T8 is enabled, the output T8_OUT switches to the initial value (CTR1, D1). If the initial value (CTR1, D1) is 0, TC8L is loaded; otherwise, TC8H is loaded into the counter. In SINGLE-PASS Mode (CTR0, D6), T8 counts down to 0 and stops, T8_OUT toggles, the timeout status bit (CTR0, D5) is set, and a timeout interrupt can be generated if it is enabled (CTR0, D1). In Modulo-N Mode, upon reaching terminal count, T8_OUT is toggled, but no interrupt is generated. From that point, T8 loads a new count (if the T8_OUT level now is 0), TC8L is loaded; if it is 1, TC8H is loaded. T8 counts down to 0, toggles T8_OUT, and sets the timeout status bit (CTR0, D5), thereby generating an interrupt if enabled (CTR0, D1). One cycle is thus completed. T8 then loads from TC8H or TC8L according to the T8_OUT level and repeats the cycle. See Figure 20.



Figure 20. 8-Bit Counter/Timer Circuits

You can modify the values in TC8H or TC8L at any time. The new values take effect when they are loaded.



Caution: To ensure known operation do not write these registers at the time the values are to be loaded into the counter/timer. *An initial count of 1 is not allowed (a non-function occurs).* An initial count of 0 causes TC8 to count from 0 to FFH to FEH.



Note: The letter h denotes hexadecimal values.

Transition from 0 to FFh is not a timeout condition.



Caution: Using the same instructions for stopping the counter/timers and setting the status bits is not recommended.

Two successive commands are necessary. First, the counter/timers must be stopped. Second, the status bits must be reset. These commands are required because it takes one counter/timer clock interval for the initiated event to actually occur. See Figure 21 and Figure 22.





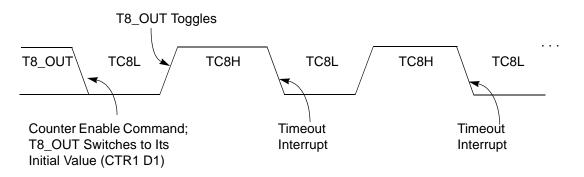


Figure 22. T8_OUT in Modulo-N Mode

T8 Demodulation Mode

The user must program TC8L and TC8H to FFH. After T8 is enabled, when the first edge (rising, falling, or both depending on CTR1, D5; D4) is detected, it starts to count down. When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current value of T8 is complemented and put into one of the capture registers. If it is a positive edge, data is put



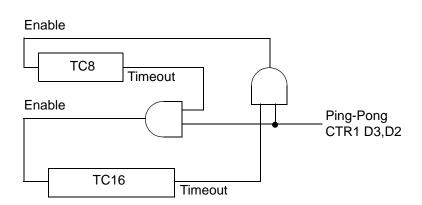


Figure 28. Ping-Pong Mode Diagram

Initiating PING-PONG Mode

First, make sure both counter/timers are not running. Set T8 into Single-Pass mode (CTR0, D6), set T16 into SINGLE-PASS mode (CTR2, D6), and set the Ping-Pong mode (CTR1, D2; D3). These instructions can be in random order. Finally, start PING-PONG mode by enabling either T8 (CTR0, D7) or T16 (CTR2, D7). See Figure 29.





The initial value of T8 or T16 must not be 1. Stopping the timer and restarting the timer reloads the initial value to avoid an unknown previous value.

ZGP323H Product Specification



Table 22. Stop Mode Recovery Source

SMR	:432		Operation		
D4	D3	D2	Description of Action		
0	0	0	POR and/or external reset recovery		
0	0	1	Reserved		
0	1	0	P31 transition		
0	1	1	P32 transition		
1	0	0	P33 transition		
1	0	1	P27 transition		
1	1	0	Logical NOR of P20 through P23		
1	1	1	Logical NOR of P20 through P27		

Note: Any Port 2 bit defined as an output drives the corresponding input to the default state. This condition allows the remaining inputs to control the AND/OR function. Refer to SMR2 register on page 61 for other recover sources.

Stop Mode Recovery Delay Select (D5)

This bit, if Low, disables the T_{POR} delay after Stop Mode Recovery. The default configuration of this bit is 1. If the "fast" wake up is selected, the Stop Mode Recovery source must be kept active for at least 5 TpC.

Note: This bit must be set to 1 if using a crystal or resonator clock source. The T_{POR} delay allows the clock source to stabilize before executing instructions.

Stop Mode Recovery Edge Select (D6)

A 1 in this bit position indicates that a High level on any one of the recovery sources wakes the device from Stop Mode. A 0 indicates Low level recovery. The default is 0 on POR.

Cold or Warm Start (D7)

This bit is read only. It is set to 1 when the device is recovered from Stop Mode. The bit is set to 0 when the device reset is other than Stop Mode Recovery (SMR).



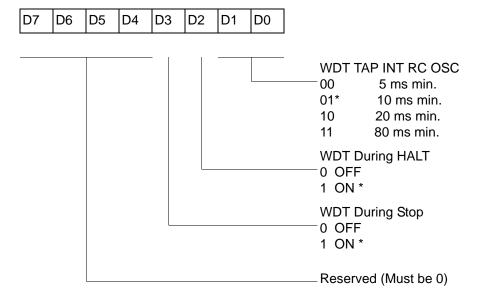
<mark>____</mark> 62

Watch-Dog Timer Mode Register (WDTMR)

The Watch-Dog Timer (WDT) is a retriggerable one-shot timer that resets the Z8[®] CPU if it reaches its terminal count. The WDT must initially be enabled by executing the WDT instruction. On subsequent executions of the WDT instruction, the WDT is refreshed. The WDT circuit is driven by an on-board RC-oscillator. The WDT instruction affects the Zero (Z), Sign (S), and Overflow (V) flags.

The POR clock source the internal RC-oscillator. Bits 0 and 1 of the WDT register control a tap circuit that determines the minimum timeout period. Bit 2 determines whether the WDT is active during HALT, and Bit 3 determines WDT activity during Stop. Bits 4 through 7 are reserved (Figure 37). This register is accessible only during the first 60 processor cycles (120 XTAL clocks) from the execution of the first instruction after Power-On-Reset, Watch-Dog Reset, or a Stop-Mode Recovery (Figure 36). After this point, the register cannot be modified by any means (intentional or otherwise). The WDTMR cannot be read. The register is located in Bank F of the Expanded Register Group at address location 0Fh. It is organized as shown in Figure 37.

WDTMR(0F)0Fh



* Default setting after reset

Figure 37. Watch-Dog Timer Mode Register (Write Only)

WDT Time Select (D0, D1)

This bit selects the WDT time period. It is configured as indicated in Table 23.





Low-Voltage Detection Register—LVD(D)0Ch

Note: Voltage detection does not work at Stop mode. It must be disabled during Stop mode in order to reduce current.

Field	Bit Position			Description
LVD	76543			Reserved No Effect
	2	R	1 0*	HVD flag set HVD flag reset
	1-	R	1 0*	LVD flag set LVD flag reset
	0	R/W	1 0*	Enable VD Disable VD
*Default	after POR			

Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Voltage Detection and Flags

The Voltage Detection register (LVD, register 0CH at the expanded register bank 0Dh) offers an option of monitoring the V_{CC} voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the the V_{CC} level is monitored in real time. The flags in the LVD register valid 20uS after Voltage Detection is enabled. The HVD flag (bit 2 of the LVD register) is set only if V_{CC} is higher than V_{HVD}. The LVD flag (bit 1 of the LVD register) is set only if V_{CC} is lower than the V_{LVD}. When Voltage Detection is enabled, the LVD flag also triggers IRQ5. The IRQ bit 5 latches the low voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a flag only.

Notes: If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt instruction (EI) prior to enabling the voltage detection.



LVD(0D)0CH



* Default setting after reset.

Figure 43. Voltage Detection Register

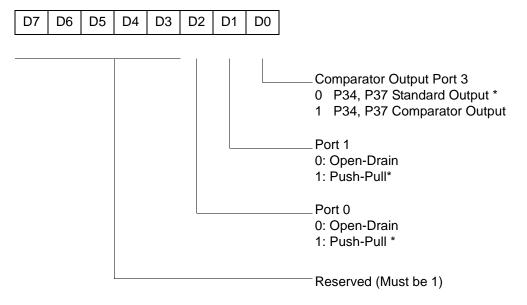
Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Expanded Register File Control Registers (0F)

The expanded register file control registers (0F) are depicted in Figures 44 through Figure 57.



PCON(0F)00H

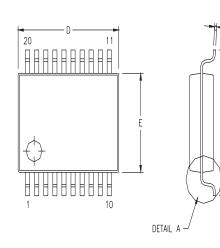


* Default setting after reset

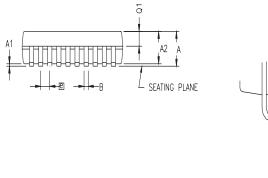
Figure 44. Port Configuration Register (PCON)(0F)00H: Write Only)







CVALDOL		MILLIMETER		INCH		
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	1.73	1.85	1.98	0.068	0.073	0.078
A1	0.05	0.13	0.21	0.002	0.005	0.008
A2	1.68	1.73	1.83	0.066	0.068	0.072
В	0.25	0.30	0.38	0.010	0.012	0.015
С	0.13	0.15	0.22	0.005	0.006	0.009
D	7.07	7.20	7.33	0.278	0.283	0.289
E	5.20	5.30	5.38	0.205	0.209	0.212
e		0.65 BSC		0.0256 BSC		
Н	7.65	7.80	7.90	0.301	0.307	0.311
L	0.56	0.75	0.94	0.022	0.030	0.037
Q1	0.74	0.78	0.82	0.029	0.031	0.032



DETAIL A

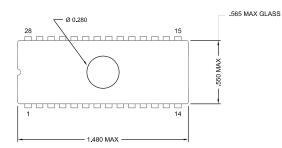
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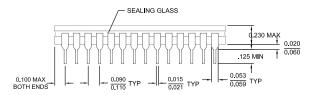
CONTROLLING DIMENSIONS : MM LEADS ARE COPLANAR WITHIN .004 INCH.

Figure 61. 20-Pin SSOP Package Diagram









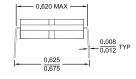
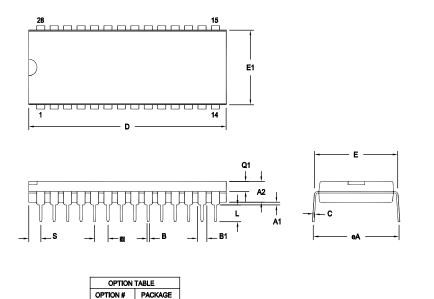
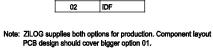


Figure 63. 28-Pin CDIP Package Diagram



SYMBOL	OPT #	MILLIN	IETER	INCH		
	OPT#	MíN	MAX	MÍN	MAX	
A1		0.38	1.02	.015	.040	
A2		3.18	4.19	.125	.165	
в		0.38	0.53	.015	.021	
B1	01	1.40	1.65	.055	.065	
	02	1.14	1.40	.045	.055	
С		0.23	0.38	.009	.015	
D	01	36.58	37.34	1.440	1.470	
5	02	35.31	35.94	1.390	1.415	
Е		15.24	15.75	.600	.620	
E1	01	13.59	14.10	.535	.555	
E1	02	12.83	13.08	.505	.515	
e		2.54	TYP	.100 BSC		
eA		15.49	16.76	.610	.660	
L		3.05	3.81	.120	.150	
Q1	01	1.40	1.91	.055	.075	
- 1	02	1.40	1.78	.055	.070	
•	01	1.52	2.29	.060	.090	
S	02	1.02	1.52	.040	.060	

CONTROLLING DIMENSIONS : INCH



01

02

STANDARD

Figure 64. 28-Pin PDIP Package Diagram





8KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323HSH4808C	48-pin SSOP 8K OTP	ZGP323HSS2808C	28-pin SOIC 8K OTP
ZGP323HSP4008C	40-pin PDIP 8K OTP	ZGP323HSH2008C	20-pin SSOP 8K OTP
ZGP323HSH2808C	28-pin SSOP 8K OTP	ZGP323HSP2008C	20-pin PDIP 8K OTP
ZGP323HSP2808C	28-pin PDIP 8K OTP	ZGP323HSS2008C	20-pin SOIC 8K OTP

8KB Extended Temperature: -40° to +105°C

-			
Part Number	Description	Part Number	Description
ZGP323HEH4808C	48-pin SSOP 8K OTP	ZGP323HES2808C	28-pin SOIC 8K OTP
ZGP323HEP4008C	40-pin PDIP 8K OTP	ZGP323HEH2008C	20-pin SSOP 8K OTP
ZGP323HEH2808C	28-pin SSOP 8K OTP	ZGP323HEP2008C	20-pin PDIP 8K OTP
ZGP323HEP2808C	28-pin PDIP 8K OTP	ZGP323HES2008C	20-pin SOIC 8K OTP

8KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323HAH4808C	48-pin SSOP 8K OTP	ZGP323HAS2808C	28-pin SOIC 8K OTP
ZGP323HAP4008C	40-pin PDIP 8K OTP	ZGP323HAH2008C	20-pin SSOP 8K OTP
ZGP323HAH2808C	28-pin SSOP 8K OTP	ZGP323HAP2008C	20-pin PDIP 8K OTP
ZGP323HAP2808C	28-pin PDIP 8K OTP	ZGP323HAS2008C	20-pin SOIC 8K OTP
Replace C with G for	r Lead-Free Packaging		





4KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323HSH4804C	48-pin SSOP 4K OTP	ZGP323HSS2804C	28-pin SOIC 4K OTP
ZGP323HSP4004C	40-pin PDIP 4K OTP	ZGP323HSH2004C	20-pin SSOP 4K OTP
ZGP323HSH2804C	28-pin SSOP 4K OTP	ZGP323HSP2004C	20-pin PDIP 4K OTP
ZGP323HSP2804C	28-pin PDIP 4K OTP	ZGP323HSS2004C	20-pin SOIC 4K OTP

4KB Extended Temperature: -40° to +105°C

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Part Number	Description	Part Number	Description
ZGP323HEH4804C	48-pin SSOP 4K OTP	ZGP323HES2804C	28-pin SOIC 4K OTP
ZGP323HEP4004C	40-pin PDIP 4K OTP	ZGP323HEH2004C	20-pin SSOP 4K OTP
ZGP323HEH2804C	28-pin SSOP 4K OTP	ZGP323HEP2004C	20-pin PDIP 4K OTP
ZGP323HEP2804C	28-pin PDIP 4K OTP	ZGP323HES2004C	20-pin SOIC 4K OTP

4KB Automotive Temperature: -40° to +125°C

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Part Number	Description	Part Number	Description
ZGP323HAH4804C	48-pin SSOP 4K OTP	ZGP323HAS2804C	28-pin SOIC 4K OTP
ZGP323HAP4004C	40-pin PDIP 4K OTP	ZGP323HAH2004C	20-pin SSOP 4K OTP
ZGP323HAH2804C	28-pin SSOP 4K OTP	ZGP323HAP2004C	20-pin PDIP 4K OTP
ZGP323HAP2804C	28-pin PDIP 4K OTP	ZGP323HAS2004C	20-pin SOIC 4K OTP
Replace C with G for	Lead-Free Packaging		

Additional Components			
Part Number	Description	Part Number	Description
ZGP323ICE01ZEM (For 3.6V Emulation only)	Emulator/programmer	ZGP32300100ZPR (Ethernet)	Programming system
		ZGP32300200ZPR (USB)	Programming system



For fast results, contact your local ZiLOG sales office for assistance in ordering the part desired.

Codes

ZG = ZiLOG General Purpose Family

P = OTP

- 323 = Family Designation
- H = High Voltage
- T = Temparature
 - S = Standard 0° to +70°C
 - $E = Extended 40^{\circ} to + 105^{\circ}C$
 - A = Automotive -40° to $+125^{\circ}$ C
- P = Package Type:
 - K = CDIP
 - P = PDIP
 - H = SSOP
 - S = SOIC

= Number of Pins

- CC = Memory Size
- M = Molding Compound
- C = Standard Plastic Packaging Molding Compound
- G = Green Plastic Molding Compound
- E = Standard Cer Dip flow